### SiHP22N60S

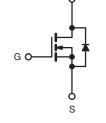




## **S Series Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> at T <sub>J</sub> max. (V)	650					
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.190				
Q <sub>g</sub> max. (nC)	98					
Q <sub>gs</sub> (nC)	17					
Q <sub>gd</sub> (nC)	25					
Configuration	Single					





N-Channel MOSFET

### FEATURES

- Generation one
- High E<sub>AR</sub> capability
- Lower figure-of-merit Ron x Qa
- 100 % avalanche tested
- Ultra low Ron
- dV/dt ruggedness
- Ultra low gate charge (Qg)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- PFC power supply stages
- Hard switching topologies
- Solar inverters
- UPS
- Motor control
- Lighting
- Server telecom

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP22N60S-E3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	600	v	
Gate-Source Voltage			V <sub>GS</sub>	± 30	v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C		22		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	13	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	65		
Linear Derating Factor		TO-220AB		2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	690	mJ	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	25		
Maximum Power Dissipation	TO-220AB		PD	250	W	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		d\//dt	37	V/ns	
Reverse Diode dV/dt <sup>d</sup>			dV/dt	5.3	v/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	*0	
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s			300	- °C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 7 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D, \, dI/dt = 100$  A/µs, starting  $T_J = 25 \ ^\circ C.$ 

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THERMAL RESISTANCE RA	TINGS							
PARAMETER		SYMBOL	TYP.	MAX.		UNIT		
Maximum Junction-to-Ambient	TO-220AB	R <sub>thJA</sub>	-	62		°C/W		
Maximum Junction-to-Case (Drain)	TO-220AB	R <sub>thJC</sub>	-	0.5				
<b>SPECIFICATIONS</b> ( $T_J = 25 \circ C$	C, unless otherw	ise noted)						
PARAMETER	SYMBOL		TEST CONDITIONS MIN.		N. T	YP.	MAX.	UNIT
Static	·							
Drain-Source Breakdown Voltage	V <sub>DS</sub>		V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	60	0	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Refe	rence to 25 °C, $I_D = 1 \text{ mA}$	-	0	.70	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V	′ <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.	0	-	4.0	V
Gate-Source Leakage	lass		$V_{GS} = \pm 20 \text{ V}$	-		-	± 100	nA
Gale-Source Leakage	I <sub>GSS</sub>		$V_{ee} = \pm 30 V$	_		_	<b>±</b> 1	114

Gate-Source Leakage	1	•G5 - ± <b>±</b> € • •				- 100	
Gale-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
Zero Gate Voltage Drain Current		$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	
Zero Gate voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 600 V	-	-	100	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 11 A	-	0.160	0.190	Ω
Forward Transconductance <sup>a</sup>	<b>g</b> fs	V <sub>DS</sub> :	= 50 V, I <sub>D</sub> = 13 A	-	9.4	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz		562	2810	5620	pF
Output Capacitance	C <sub>oss</sub>			296	1480	2960	
Reverse Transfer Capacitance	C <sub>rss</sub>			6.6	33	66	
Effective Output Capacitance (Time Related)	C <sub>oss eff.</sub> (TR) <sup>a</sup>	$V_{GS} = 0 V$	$V_{DS} = 0 V$ to 480 V	-	155	-	
Total Gate Charge	Qg			-	75	110	1
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$I_D = 22 \text{ A}, V_{DS} = 480 \text{ V}$	-	17	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	25	-	1
Turn-On Delay Time	t <sub>d(on)</sub>			-	24	50	
Rise Time	t <sub>r</sub>	$\begin{array}{l} V_{DD} = 380 \; V, \; I_{D} = 22 \; A, \\ R_{g} = 9.1 \; \Omega, \; V_{GS} = 10 \; V \end{array}$		-	68	100	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	77	115	
Fall Time	t <sub>f</sub>			-	59	90	1
Gate Input Resistance	R <sub>g</sub>	f = 1	0.13	0.65	1.3	Ω	
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	А
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	88	
Diode Forward Voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = 22 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> , dl/dt = 100 A/μs, V <sub>R</sub> = 25 V		-	462	690	ns
Reverse Recovery Charge	Q <sub>rr</sub>			-	8.3	16	μC
Reverse Recovery Current	I <sub>RRM</sub>			-	30	60	Α

Note

a.  $C_{\text{oss eff.}}$  (TR) is a fixed capacitance that gives the same charging time as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 % to 80 %  $V_{\text{DS}}$ .





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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

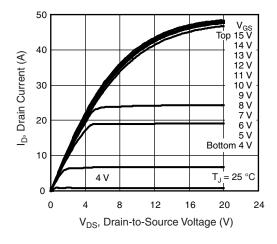


Fig. 1 - Typical Output Characteristics, T<sub>J</sub> = 25 °C

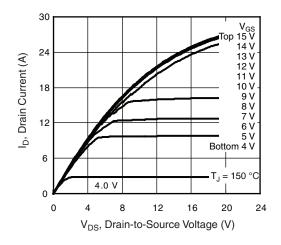


Fig. 2 - Typical Output Characteristics,  $T_J$  = 150 °C

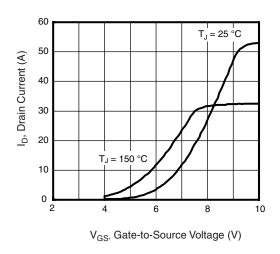


Fig. 3 - Typical Transfer Characteristics

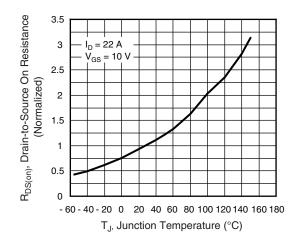


Fig. 4 - Normalized On-Resistance vs. Temperature

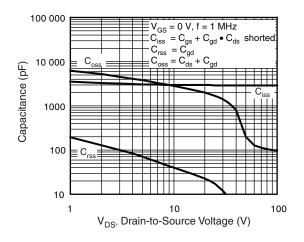


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

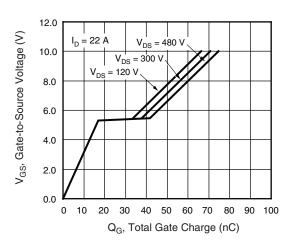


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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3 For technical questions, contact: <u>hvm@vishay.com</u>

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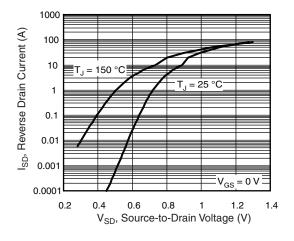


Fig. 7 - Typical Source-Drain Diode Forward Voltage

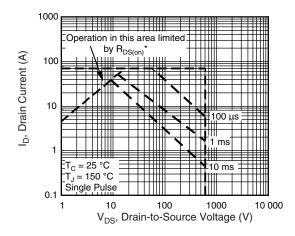


Fig. 8 - Maximum Safe Operating Area

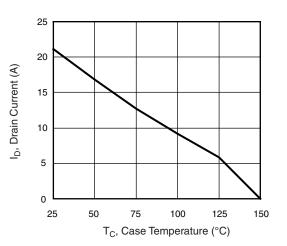


Fig. 9 - Maximum Drain Current vs. Case Temperature

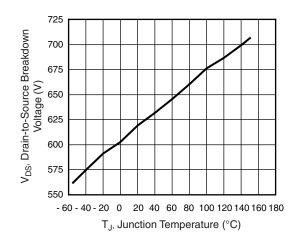
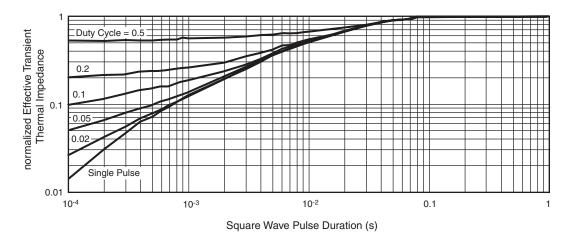


Fig. 10 - Drain-to-Source Breakdown Voltage





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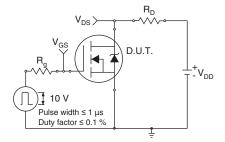


Fig. 12 - Switching Time Test Circuit

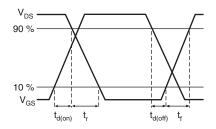


Fig. 13 - Switching Time Waveforms

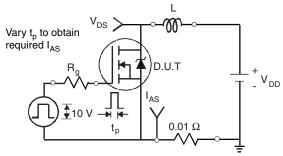


Fig. 14 - Unclamped Inductive Test Circuit

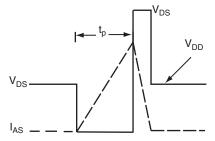


Fig. 15 - Unclamped Inductive Waveforms

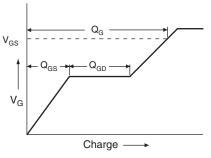


Fig. 16 - Basic Gate Charge Waveform

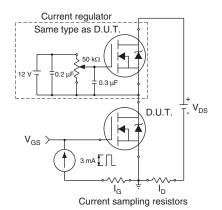


Fig. 17 - Gate Charge Test Circuit

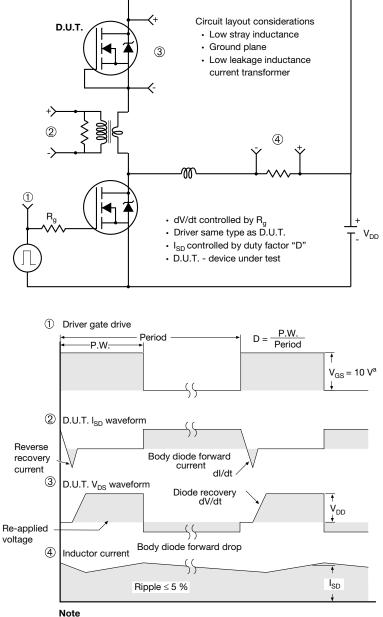
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 18 - For N-Channel

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